

CRYSTAL OSCILLATOR SPXO

SG-645/SG-636 series

: 2.21675 MHz to 135 MHz Frequency range : 2.5 V / 3.3 V / 5.0 V Supply voltage

Function : Output enable(OE) Standby(ST)

: SG-645:1.5 mm Max. Thickness

SG-636:2.7 mm Max.







Actual size

SG-645 series

SG-636 series





Specifications (characteristics)

ltem		Symbol	Specifications				
			SG-636 PTF	SG-636 PH	SG-636 PCE SG-636 SCE	SG-636 PDE	Remarks
Output frequency range		f o	2.21675 MHz to 41.000 MHz	41.001 MHz to 70.000 MHz	2.21675 MHz to 40.000 MHz	2.21675 MHz to 40.000 MHz	
Supply voltage		Vcc	5.0 V ±0.5 V		3.3 V ±0.3 V	2.5 V ±0.25 V	
Storage Temperature temperature		T_stg	-55 °C to +100 °C				Store as bare product after unpacking
range	Operating temperature	T_use		-20 °C to			
Frequency tolerance		f_tol(osc)		C: ±100	-20 °C to +70 °C		
Current con	sumption	lcc	17 mA Max.	35 mA Max.	9 mA Max.	5 mA Max.	No load condition
Output disa	ble current	I_dis	10 mA Max.	20 mA Max.	5 mA Max.	3 mA Max.	OE=GND
Stand-by current		I_std			2 μA Max.	_	ST =GND(SCE)
Symmetry	Symmotry		40 % to 60 % 45 % to 55 %				CMOS load:50 % Vcc level
Oyillilletry		SYM					TTL load: 1.4 V level
High output voltage		Vон	Vcc-0.4 V Min.				IOH=-8 mA(PTF)/-4 mA(PH,SCE,PCE), /-3.2 mA(PDE)
Low output voltage		Vol	0.4 V Max.				loL=16 mA(PTF)/4mA(PH,SCE,PCE) /3.2 mA(PDE)
Output load condition (TTL)		L_TTL	10 TTL Max.	_			L_CMOS ≤ 15 pF
Output load (CMOS)	I condition	L_CMOS	50 pF Max.	20 pF Max.(≤55 MHz) 15 pF Max.(>55 MHz)	30 pF Max.	15 pF Max.	
Output enable /		ViH	2.0 V Min. 80 % Vcc Min.		cc Min.	OE Terminal, ST Terminal (SCE)	
disable input voltage		VIL	0.8 V Max.		20 % Vcc Max.		* *
Output rise and fall time		tr / tf	7 ns Max. 5 ns Max.			CMOS load:20 % Vcc to 80 % Vcc level	
			5 ns Max.				TTL load:0.4 V to 2.4 V level
Oscillation start up time		tosc	4 ms Max.	10 ms Max. 4 ms Max.			Time at minimum supply voltage to be 0 s
Frequency aging		f_aging	±5 × 10 ⁻⁶ / year Max.				+25 °C, Vcc=5.0 V/3.3 V/2.5 V, First year

Specifications (characteristics)

		Cifiti			
Symbol		·	SG-636 PCG	Remarks	
Cymbol	SG-636 PTG	SG-636 PHG	SG-636 SCG	romano	
fo	2.21675 MHz to 33.000 MHz *1				
Vcc	4.5 V to 5.5 V		2.7 V to 3.6 V		
T_stg		-55 °C to +100 °C		Store as bare product after unpacking	
	-20 °C to +70 °C				
f_tol(osc)	B: ±50 × 10 ⁻⁶ C: ±100 × 10 ⁻⁶			-20 °C to +70 °C	
Icc	25 mA Max.		12 mA Max.	No load condition	
I_dis	20 mA Max.		10 mA Max.	OE=GND (PTG,PHG,PCG)	
I_std	_		50 μA Max.	ST =GND (SCG)	
CVM				50 % Vcc level, L_CMOS=25 pF	
STIVI	40 % to 60 %			1.4 V level, L_CMOS=25 pF	
Vou	2.4 V Min.	_	Vcc-0.4 V Min.	Iон=-8 mA	
VOH	_	Vcc-0.4 V Min.	_	Iон=-16 mA	
Voi	— 0.4 V Max.			loL=8 mA	
VOL	0.4 V Max.		_	loL=16 mA	
L_CMOS	25 pF Max.				
VIH	2.0 V Min.		70 % Vcc Min.	OE Terminal , ST Terminal	
VIL	0.8 V Max.		20 % Vcc Max.	, -	
t. / t/	_	3.4 ns Max.	4 ns Max.	20 % Vcc to 80 % Vcc level, L_CMOS ≤ 25 pF	
Lr / Li	2.4 ns Max. —			TTL load:0.4 V to 2.4 V level, L_CMOS ≤ 25 pF	
tosc	12 ms Max.			t=0 at 90 % Vcc	
f_aging	$\pm 5 \times 10^{-6}$ / year Max.			+25 °C, Vcc=5.0 V/ 3.3 V, First year	
	Vcc T_stg T_use f_tol(osc) Icc I_dis I_std SYM VoH VoL L_CMOS ViH ViL t_r/t_f tosc	SG-636 PTG Color Color	fo 2.21675 MHz to 33.000 MHz Vcc 4.5 V to 5.5 V T_stg -55 °C to +100 °C f_tol(osc) B: ±50 × 10 °6 C: ±100 × Icc 25 mA Max. I_dis 20 mA Max. I_std - 45 % SYM 40 % to 60 % VoH - Vcc-0.4 V Min. VoL 0.4 V Max. L_CMOS 25 pF Max. Vih 2.0 V Min. Vil 0.8 V Max. tr/tf - 3.4 ns Max. 12 ms Max.	Symbol SG-636 PTG SG-636 PHG SG-636 PCG SG-636 SCG f ₀ 2.21675 MHz to 33.000 MHz *1 Vcc 4.5 V to 5.5 V 2.7 V to 3.6 V g T_stg -55 °C to +100 °C f_tol(osc) B: ±50 × 10 °C 10 °C lcc 25 mA Max 12 mA Max l_dis 20 mA Max 10 mA Max l_std — 50 μA Max SYM 40 % to 60 % — VOH — Vcc-0.4 V Min VOL — Vcc-0.4 V Min VOL — 0.4 V Max L_CMOS 25 pF Max VIH 2.0 V Min 70 % Vcc Min VIL 0.8 V Max 20 % Vcc Max tr/tf — 3.4 ns Max 4 ns Max tosc 12 ms Max —	

^{*1 4.1250} MHz < f_0 < 4.4336 MHz, 8.2500 MHz < f_0 < 8.8672 MHz, 16.500 MHz < f_0 < 17.7344 MHz: Unavailable

Specifications (characteristics)

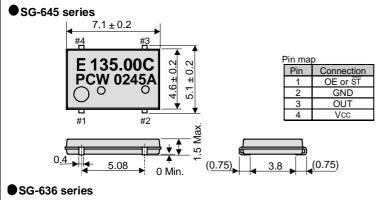
ltem				Specifications		
		Symbol	SG-636 PTW / STW	SG-636 PHW / SHW	SG-636 PCW / SCW	Remarks
			SG-645 PTW / STW	SG-645 PHW / SHW	SG-645 PCW / SCW	
Output frequency range		fo	32	2.001 MHz to 135.000 MH		
Supply voltage		Vcc	5.0 V ±0.5 V		3.3 V ±0.3 V	
Temperature	Storage temperature	T_stg	SG-636P**:-55 °C	to +100 °C / SG-645P**	-55 °C to +125 °C	Store as bare product after unpacking
range	Operating	T_use	-20 °C to +70 °C			
	temperature		-	_	-40 °C to +85 °C	SG-645PCW / SCW Only
Frequency tolerance		f_tol(osc)	B: ±50 × 10 ⁻⁶ C: ±100 × 10 ⁻⁶			-20 °C to +70 °C *1
			— M: ±50 × 10 ⁻⁶		M: $\pm 50 \times 10^{-6}$	-40 °C to +85 °C : SG-645PCW / SCW Only
Current consumption		Icc	45 mA Max.		28 mA Max.	No load condition(Max. frequency range)
Output disabl	Output disable current		30 mA Max.		16 mA Max.	OE=GND (PTW,PHW,PCW)
Stand-by current		l_std	50 μA Max.			ST =GND (STW,SHW,SCW)
Symmetry		SYM	— 40 % to 60 %			50 % Vcc level, L_CMOS=Max.
		STIVI	40 % to 60 %			1.4 V level, L_CMOS=Max.
High output voltage		Voн	Vcc-0.4 V Min.			IoH=-16 mA(PTW , STW , PHW , SHW) /-8 mA(PCW , SCW)
Low output voltage		Vol	0.4 ∨ Max.			IoL= 16 mA(PTW, STW, PHW, SHW) / 8 mA(PCW, SCW)
Output load condition (TTL)		L_TTL	5 TTL Max.	_	_	fo≤ 90 MHz, Max.Supply voltage.
Output load condition (CMOS)		L_CMOS	15 pF Max.			Max.frequency, Max.Supply voltage.
Output enable /		VIH	2.0 V	/ Min.	70 % Vcc Min.	OE Terminal , ST Terminal
disable input voltage		VIL	0.8 V	Max.	20 % Vcc Max.	
Output rise and fall time		t _r / t _f	— 4 ns Max.			20 % Vcc to 80 % Vcc level, L_CMOS ≤ Max.
			4 ns Max.	_	_	0.4 V to 2.4 V level
Oscillation start up time		tosc	10 ms Max.			Time at minimum supply voltage to be 0 s
Frequency aging		f_aging		$\pm 5 \times 10^{-6}$ / year Max.	+25 °C, Vcc=5.0 V / 3.3 V, First year	

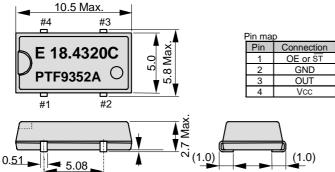
^{*1} SG-636 series "C" tolerance : 40 MHz<fo≤135 MHz



(Unit:mm)







Metal may be exposed on the top or bottom of this product. This will not affect any quality, reliability or electrical spec.

Note.

OE pin (PTF,PH,PCE,PDE,PTW,PHW,PCW,PTG,PHG,PCG)

OE pin = "H" or "open" : Specified frequency output.
OE pin = "L" : Output is high impedance.

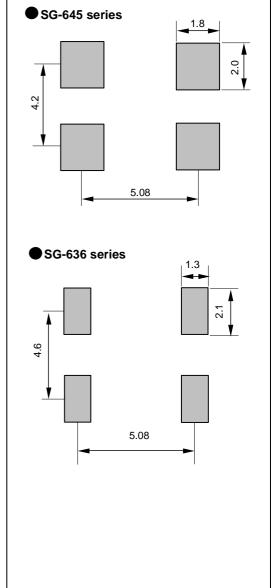
ST pin (STW, SHW, SCW,SCG)

ST pin = "H" or "open" : Specified frequency output.
ST pin = "L" : Output is low level (weak pull - down),oscillation stops.

0.05Min.

ST pin (SCE)

 \underline{ST} pin (SGL) \underline{ST} pin = "H" or "open" : Specified frequency output. \underline{ST} pin = "L" : Output is low level ,oscillation stops.



3.6

"Quartz + MEMS" EPSON TOYOCOM

In order to meet customer needs in a rapidly advancing digital, broadband and ubiquitous society, we are committed to offering products that are one step ahead of the market and a rank above the rest in quality. To achieve our goals, we follow a "3D (three device) strategy" designed to drive both horizontal and vertical growth. We will to grow our three device categories of "Timing Devices", "Sensing Devices" and "Optical Devices", and expand vertical growth through a combination of products from these categories.

A Quartz MEMS is any high added value quartz device that exploits the characteristics of quartz crystal material but that is produced using MEMS (micro-electro-mechanical system) processing technology.

Market needs are advancing faster than previously imagined toward smaller, more stable crystal products, but we will stay ahead of the curve by rolling out products that exceed market speed and quality requirements. We want to further accelerate the 3D strategy by QMEMS.

Quartz devices have become crucial in the network environment where products are increasingly intended for broadband, ubiquitous applications and where various types of terminals can transfer information almost immediately via LAN and WAN on a global scale. Epson Toyocom Corporation addresses every single aspect within a network environment. The new corporation offers "Digital Convergence" solutions to problems arising with products for consumer use, such as, core network systems and automotive systems.

PROMOTION OF ENVIRONMENTAL MANAGEMENT SYSTEM CONFORMING TO INTERNATIONAL STANDARDS

At Epson Toyocom, all environmental initiatives operate under the Plan-Do-Check-Action(PDCA) cycle designed to achieve continuous improvements. The environmental management system (EMS) operates under the ISO 14001 environmental management standard.

All of our major manufacturing and non-manufacturing sites, in Japan and overseas, completed the acquisition of ISO 14001 certification.

In the future, new group companies will be expected to acquire the certification around the third year of operations.

ISO 14000 is an international standard for environmental management that was established by the International Standards Organization in 1996 against the background of growing concern regarding global warming, destruction of the ozone layer, and global deforestation.

WORKING FOR HIGH QUALITY

In order provide high quality and reliable products and services than meet customer needs,

Epson Toyocom made early efforts towards obtaining ISO9000 series certification and has acquired ISO9001 for all business establishments in Japan and abroad. We have also acquired ISO/TS 16949 certification that is requested strongly by major automotive manufacturers as standard.

QS-9000 is an enhanced standard for quality assurance systems formulated by leading U.S. automobile manufacturers based on the international ISO 9000 series.

ISO/TS 16949 is a global standard based on QS-9000, a severe standard corresponding to the requirements from the automobile industry.

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- / Medical instruments to sustain life / Submarine transmitters / Power stations and related / Fire work equipment and security equipment / traffic control equipment / and others requiring equivalent reliability.
- In this new crystal master for Epson Toyocom, product codes and markings will remain as previously identified prior to the merger.

 Due to the on-going strategy of gradual unification of part numbers, please review product codes and markings, as they will change during the course of the coming months.
 - We apologize for the inconvenience, but we will eventually have a unified part numbering system for Epson Toyocom that will be user friendly.